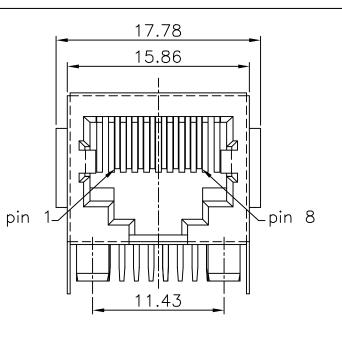
494-0330 18.34 2.67 95125 (408) Ω 50±0.40 0.50 S W. Jose, San 2.54 8.89 3.05 Street, Orchard Little 1810 typ. KYCON Inc. .27



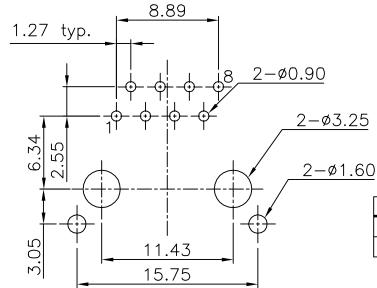
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3.

PCB LAYOUT/TOP VIEW



Materials and Finish

Housing Material-PBT Thermoplastic UL 94V-0 Rated Color: Black

Shield Material-Nickel Plated Copper Alloy

Contact Material-Phosphor Bronze

Contact Plating Options-Standard: 0.0001" Nickel Plating, Selective Plating 0.000015" Gold on Contact Area

50: 0.0001" Nickel Plating, Selective Plating 0.000050" Gold on Contact Area to Comply with FCC Requirements Under No. 47 C.F.R. Part 68, Subpart F

Electrical Characteristics

Insulation Resistance-500 Megohms Min.

Dielectric Withstanding Voltage-1000V rms, 60Hz

Contact Resistance-20 milliohms Max.

Current Rating-1.5 Amps

Part Number	Contact Area Plating Finish		
GDL-S-88	15u" Gold (standard)		
GDL-S-88-50	50u" Gold (50 option)		

See CSA NRTL/C Certified File No. LR78160

REVISION	DATE	DESCRIPTION	DRAWN BY	CHECKED BY	UNITS
В3	12/11/00	Modify Pins	K. Wallace		mm
В4	8/16/01	per ECD #01-047	REVISED BY	APPROVED BY	DATE
C1	4/9/02	per ECO #01-066	C. Leiva		11/29/00

GDL-S-88

Modular Jack, Right angle

8 Pos, 8 Contacts, shielded

